

INTERNATIONAL
GEMOLOGICAL
INSTITUTE

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LABORATORY GROWN DIAMOND REPORT

August 2, 2025

IGI Report Number

LG726559596

Description

LABORATORY GROWN DIAMOND

Shape and Cutting Style

PRINCESS CUT

Measurements

7.06 X 6.91 X 4.94 MM

GRADING RESULTS

Carat Weight

2.16 CARATS

Color Grade

D

Clarity Grade

VVS 1

ADDITIONAL GRADING INFORMATION

Polish

EXCELLENT


Symmetry

EXCELLENT

Fluorescence

NONE

Inscription(s)

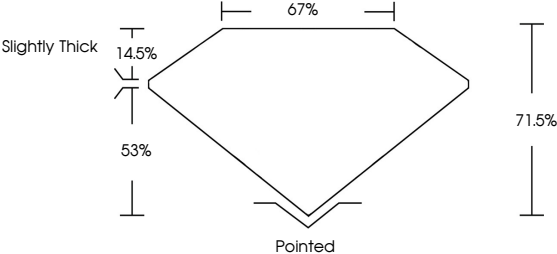
 LG726559596


Comments: As Grown - No indication of post-growth treatment.
This Laboratory Grown Diamond was created by High Pressure High Temperature (HPHT) growth process.
Type II

LG726559596

Report verification at [igi.org](https://www.igi.org)

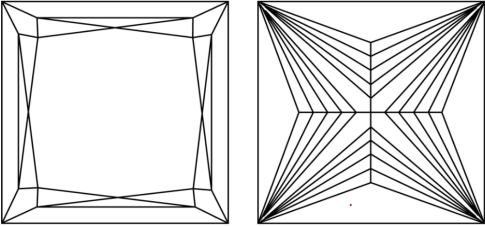
PROPORTIONS





Sample Image Used

CLARITY CHARACTERISTICS



KEY TO SYMBOLS

Red symbols indicate internal characteristics.
Green symbols indicate external characteristics.

COLOR

D E F G H I J Faint Very Light Light

CLARITY

IF VS ¹⁻² VS ¹⁻² SI ¹⁻² I ¹⁻³

Internally Flawless Very Very Slightly Included Very Slightly Included Slightly Included Included

ADDITIONAL GRADING INFORMATION

Polish

EXCELLENT


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IGI

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IGI Report No LG726559596

PRINCESS CUT

7.06 X 6.91 X 4.94 MM

2.16 CARATS

D

VS 1

71.5%

67%

Slightly Thick

Pointed

EXCELLENT

EXCELLENT

NONE

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